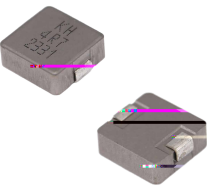


k
SMD Low Profile High Current Molded Inductor
Size 1350

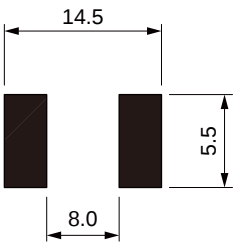
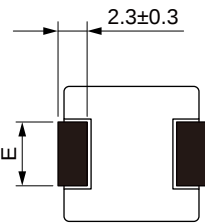
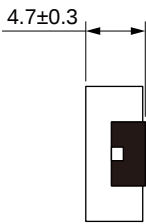
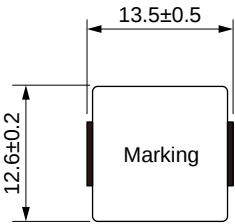


M

M

Dimensions: [mm]

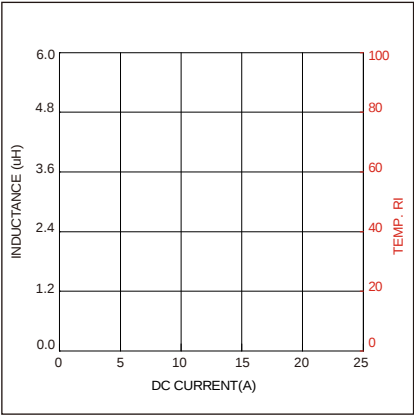
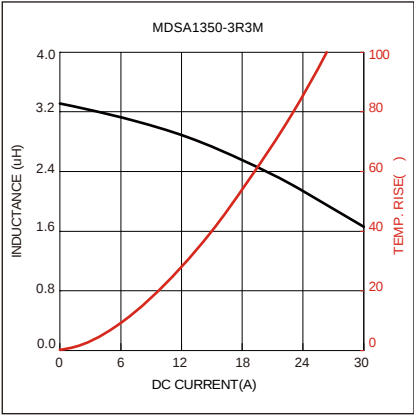
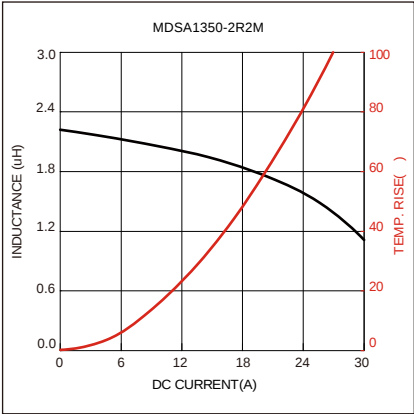
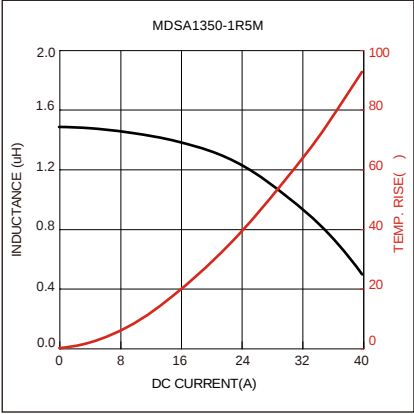
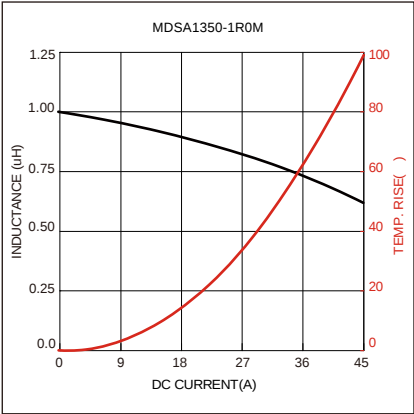
Land Pattern: [mm]



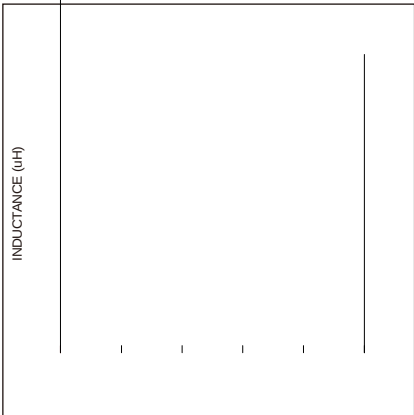
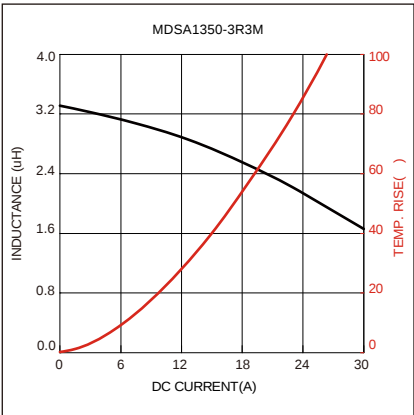
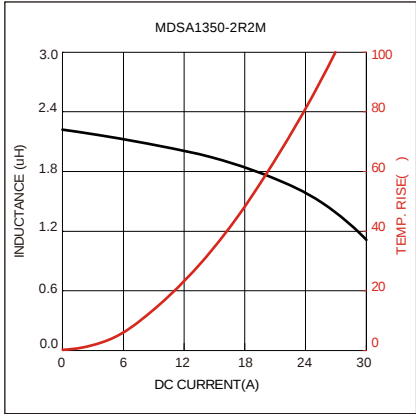
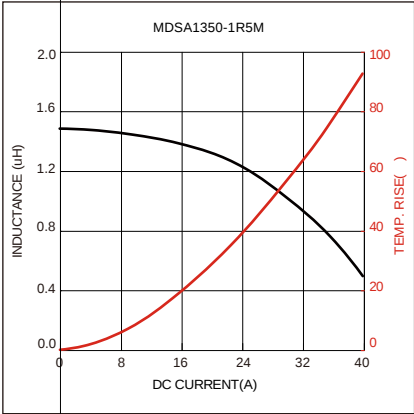
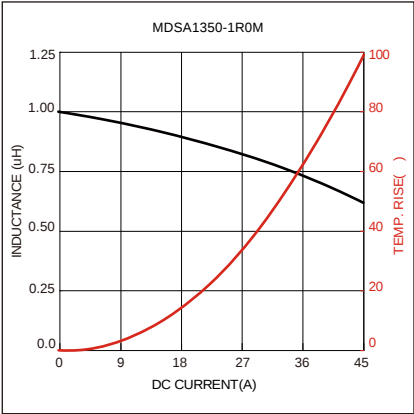
Electrical Properties:

	(μH)			Saturation	(mΩ)	(mΩ)	

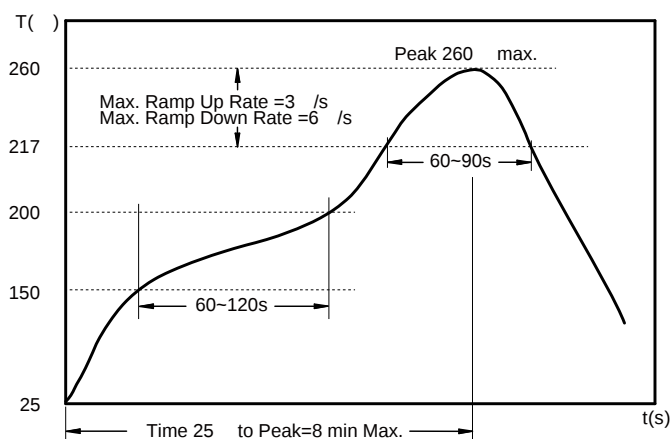
Typical Electrical Characteristics:



Typical Electrical Characteristics:



Soldering Reflow:



Preheat condition: 150 ~200 °C / 60~120 sec.

Allowed time above 217 °C : 60~90 sec.

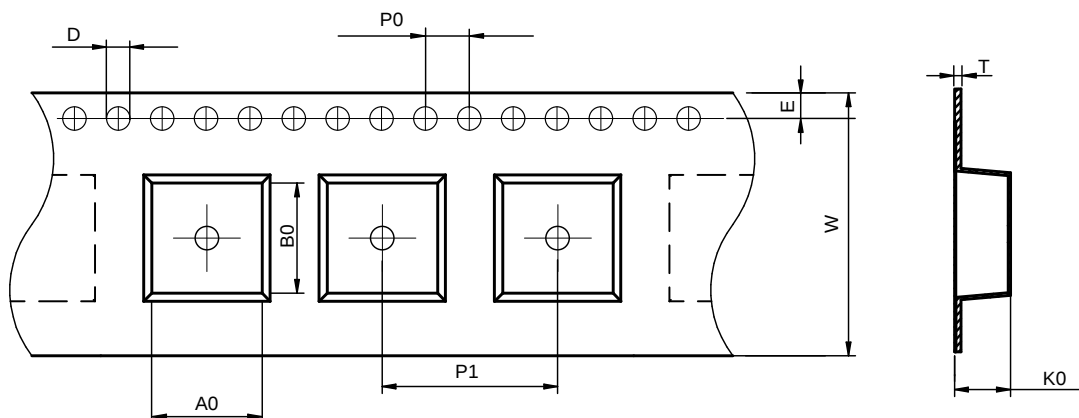
Max temperature: 260 °C.

Max time at max temperature: 10 sec.

Allowed Reflow time: 2x max.

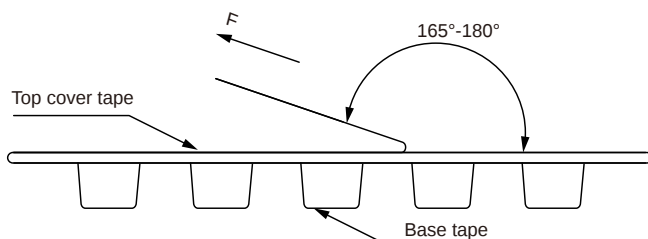
Packaging Information:

Tape Dimension :



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDSA1350	13.1 ± 0.1	14.0 ± 0.1	1.5 ± 0.1	4.0 ± 0.1	16.0 ± 0.1	24.0 ± 0.3	5.4 ± 0.1	1.75 ± 0.1	0.50 ± 0.05

Peel force of top cover tape:

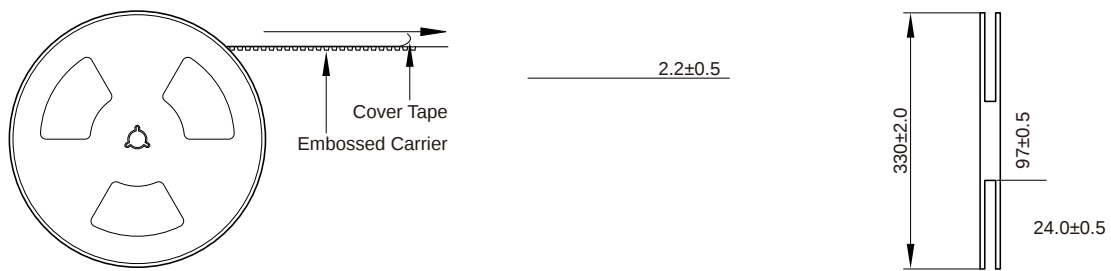


The peel force of top cover tape shall be between 0.1 to 1.3 N

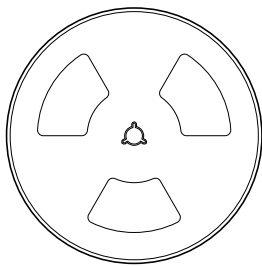
Product Marking:

Marking	KH+Printing Inductance+period)
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Reel Dimension : [mm]



Packaging Quantity:



500 Pcs/Reel



2 Reel /Inner box(1000 Pcs)



2 Inner box/Carton box(2K Pcs)

Cautions and Warnings:

Storage Conditions :

Operation Instructions: